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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	MIPS32® microAptiv™
Core Size	32-Bit Single-Core
Speed	25MHz
Connectivity	IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, I ² S, POR, PWM, WDT
Number of I/O	16
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 11x10/12b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mm0016gpl020-i-ss

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TABLE 2: COMPLETE PIN FUNCTION DESCRIPTIONS FOR 20-PIN SSOP DEVICES

Pin	Function	Pin	Function
1	MCLR	11	RP11 /RB7
2	PGEC2/VREF+/AN0/ RP1 /OCM1E/INT3/RA0	12	TCK/ RP7 /U1CTS/SCK1/OCM1A/RB8 ⁽¹⁾
3	PGED2/VREF-/AN1/ RP2 /OCM1F/RA1	13	TMS/REFCLKI/ RP8 /T1CK/T1G/ <mark>U1RTS</mark> /U1BCLK/SDO1/C2OUT/OCM1B/ INT2/RB9 ⁽¹⁾
4	PGED1/AN2/C1IND/C2INB/ RP14 /RB0	14	VCAP
5	PGEC1/AN3/C1INC/C2INA/ RP15 /RB1	15	TDO/AN7/LVDIN/ RP12 /RB12
6	AN4/ RP16 /RB2	16	TDI/AN8/ RP13 /RB13
7	OSC1/CLKI/AN5/C1INB/RP3/OCM1C/RA2	17	CDAC1/AN9/RP9/RTCC/U1TX/SDI1/C1OUT/INT1/RB14
8	OSC2/CLKO/AN6/C1INA/ RP4 /OCM1D/RA3 ⁽¹⁾	18	AN10/REFCLKO/RP10/U1RX/SS1/FSYNC1/INT0/RB15 ⁽¹⁾
9	PGED3/SOSCI/ RP5 /RB4	19	AVss/Vss
10	PGEC3/SOSCO/SCLKI/ RP6 /PWRLCLK/RA4	20	AVdd/Vdd

Note 1: Pin has an increased current drive strength.

Pin Diagrams (Continued)



TABLE 5: COMPLETE PIN FUNCTION DESCRIPTIONS FOR 28-PIN QFN/UQFN DEVICES

Pin	Function	Pin	Function
1	PGED1/AN2/C1IND/C2INB /RP14 /RB0	15	TMS/REFCLKI/ RP8 /T1CK/T1G/U1RTS/U1BCLK/SDO1/C2OUT/OCM1B/ INT2/RB9 ⁽¹⁾
2	PGEC1/AN3/C1INC/C2INA/ RP15 /RB1	16	RP19/RC9
3	AN4/C1INB/ RP16 /RB2	17	VCAP
4	AN11/C1INA/RB3	18	PGED2/TDO/ RP17 /RB10
5	Vss	19	PGEC2/TDI/ RP18 /RB11
6	OSC1/CLKI/AN5/RP3/OCM1C/RA2	20	AN7/LVDIN/ RP12 /RB12
7	OSC2/CLKO/AN6/ RP4 /OCM1D/RA3 ⁽¹⁾	21	AN8/ RP13 /RB13
8	SOSCI/ RP5 /RB4	22	CDAC1/AN9/ RP9 /RTCC/U1TX/SDI1/C1OUT/INT1/RB14
9	SOSCO/SCLKI/ RP6 /PWRLCLK/RA4	23	AN10/REFCLKO/ RP10 /U1RX/SS1/FSYNC1/INT0/RB15 ⁽¹⁾
10	Vdd	24	AVss
11	PGED3/RB5	25	AVDD
12	PGEC3/RB6	26	MCLR
13	RP11 /RB7	27	VREF+/AN0/ RP1 /OCM1E/INT3/RA0
14	TCK/RP7/U1CTS/SCK1/OCM1A/RB8 ⁽¹⁾	28	VREF-/AN1/ RP2 /OCM1F/RA1

Note 1: Pin has an increased current drive strength.

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	r-1	R/W-0	R/W-1	R/W-0	R/W-0	R/W-1	R/W-0	r-0
31:24	—		K23<2:0>			KU<2:0>		—
00.40	r-0	R-0	R-1	R-0	r-0	r-0	r-0	R-1
23:10	-	UDI	SB	MDU	—	—	—	DS
45.0	R-0	R-0	R-0	R-0	R-0	R-1	R-0	R-1
15:8	BE	AT<	1:0>	AR<2:0>			MT<2:1>	
7:0	R-1	r-0	r-0	r-0	r-0	R/W-0	R/W-1	R/W-0
7:0	MT<0>	—	—	_	_	K0<2:0>		

REGISTER 3-1: CONFIG: CONFIGURATION REGISTER; CP0 REGISTER 16, SELECT 0

Legend:	r = Reserved bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 Reserved: This bit is hardwired to '1' to indicate the presence of the CONFIG1 register

bit 30-28	K23<2:0>: Cacheability of the kseg2 and kseg3 Segments bits
h:+ 07 05	KIL 200 - Coshashility of the lugar and user Cormente hits
DIL 27-25	KU<2:U>: Cacheability of the kuseg and useg Segments bits
	010 = Cache is not implemented
bit 24-23	Reserved: Must be written as zeros; returns zeros on reads
bit 22	UDI: User-Defined bit
	0 = CorExtend user-defined instructions are not implemented
bit 21	SB: SimpleBE bit
	1 = Only simple byte enables are allowed on the internal bus interface
bit 20	MDU: Multiply/Divide Unit bit
	0 = Fast, high-performance MDU
bit 19-17	Reserved: Must be written as zeros; returns zeros on reads
bit 16	DS: Dual SRAM Interface bit
	1 = Dual instruction/data SRAM interface
bit 15	BE: Endian Mode bit
	0 = Little-endian
bit 14-13	AT<1:0>: Architecture Type bits
	00 = MIPS32 [®]
bit 12-10	AR<2:0>: Architecture Revision Level bits
	001 = MIPS32 Release 2
bit 9-7	MT<2:0>: MMU Type bits
	011 = Fixed mapping
bit 6-3	Reserved: Must be written as zeros; returns zeros on reads

bit 2-0 **K0<2:0>:** kseg0 Coherency Algorithm bits 010 = Cache is not implemented

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	-	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:10	—	—	—	—	-	—	-	—
45.0	R/W-0, HC	R/W-0	R-0, HS, HC	R-0, HS, HC	r-0	U-0	U-0	U-0
15:8	WR ^(1,4)	WREN ⁽¹⁾	WRERR ^(1,2)	LVDERR ^(1,2)	_	—	_	—
7:0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
	_	_	_	_		NVMOP<3:0>(3)		

REGISTER 5-1: NVMCON: NVM PROGRAMMING CONTROL REGISTER

Legend:	HS = Hardware Settable bit	HC = Hardware Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	r = Reserved bit	

bit 31-16 Unimplemented: Read as '0'

- bit 15 WR: Write Control bit^(1,4)
 - This bit cannot be cleared and can be set only when WREN = 1, and the unlock sequence has been performed. 1 = Initiates a Flash operation
 - 0 = Flash operation is complete or inactive

bit 14 WREN: Write Enable bit⁽¹⁾

- 1 = Enables writes to the WR bit and disables writes to the NVMOP<3:0> bits
- 0 = Disables writes to the WR bit and enables writes to the NVMOP<3:0> bits

bit 13 WRERR: Write Error bit^(1,2)

This bit can be cleared only by setting the NVMOP<3:0> bits = 0000 and initiating a Flash operation.

- 1 = Program or erase sequence did not complete successfully
- 0 = Program or erase sequence completed normally

bit 12 LVDERR: Low-Voltage Detect Error bit^(1,2)

This bit can be cleared only by setting the NVMOP<3:0> bits = 0000 and initiating a Flash operation. 1 = Low voltage is detected (possible data corruption if WRERR is set)

- 0 = Voltage level is acceptable for programming
- bit 11 Reserved: Maintain as '0'
- bit 10-4 Unimplemented: Read as '0'
- **Note 1:** These bits are only reset by a Power-on Reset (POR) and are not affected by other Reset sources.
 - 2: These bits are cleared by setting NVMOP<3:0> = 0000 and initiating a Flash operation (i.e., WR).
 - 3: NVMOP<3:0> bits are write-protected if the WREN bit is set.
 - 4: Writes to the WR bit require an unlock sequence. Refer to Section 5.1 "Flash Controller Registers Write Protection" for details.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	—	—	—	—	—	—	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:10	—	—	—	—	—	—	—	—
45.0	R/W-1	U-0	U-0	U-0	U-0	R/W-1	R/W-1	R/W-1
15:8	BWPULOCK	_	—	—	—	BWP2 ⁽²⁾	BWP1 ⁽²⁾	BWP0 ⁽²⁾
7.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
7:0	_	_	_	_	_	_	_	_

REGISTER 5-7: NVMBWP: NVM BOOT FLASH (PAGE) WRITE-PROTECT REGISTER⁽¹⁾

Legend:

3					
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-16 Unimplemented: Read as '0'

- bit 15 **BWPULOCK:** Boot Alias Write-Protect Unlock bit
 - 1 = BWPx bits are not locked and can be modified
 - 0 = BWPx bits are locked and cannot be modified
 - This bit is only clearable and cannot be set except by any Reset.
- bit 14-11 Unimplemented: Read as '0'
- bit 10 **BWP2:** Boot Alias Page 2 Write-Protect bit⁽²⁾
 - 1 = Write protection for physical address, 0x1FC00000 through 0x1FC007FF, is enabled 0 = Write protection for physical address, 0x1FC00000 through 0x1FC007FF, is disabled
- bit 9 **BWP1:** Boot Alias Page 1 Write-Protect bit⁽²⁾
 - 1 = Write protection for physical address, 0x1FC00800 through 0x1FC00FFF, is enabled
 - 0 = Write protection for physical address, 0x1FC00800 through 0x1FC00FFF, is disabled
- bit 8 **BWP0:** Boot Alias Page 0 Write-Protect bit⁽²⁾
 - 1 = Write protection for physical address, 0x1FC01000 through 0x1FC017FF, is enabled
 - 0 = Write protection for physical address, 0x1FC01000 through 0x1FC017FF, is disabled
- bit 7-0 Unimplemented: Read as '0'
- Note 1: Writes to this register require an NVMKEY unlock sequence. Refer to Section 5.1 "Flash Controller Registers Write Protection" for details.
 - 2: These bits can be modified only when the associated unlock bit (BWPULOCK) is set.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
31:24	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
	_	—	—	IP3<2:0>			IS3<1:0>		
00.40	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
23.10	-	—	—		IP2<2:0>			IS2<1:0>	
45.0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
15:8	_	—	—		IP1<2:0>			:1:0>	
7:0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
		_	_	IP0<2:0>			IS0<	:1:0>	

REGISTER 7-7: IPCx: INTERRUPT PRIORITY CONTROL REGISTER x⁽¹⁾

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-29 Unimplemented: Read as '0'

bit 28-26 IP3<2:0>: Interrupt Priority bits

- 111 = Interrupt priority is 7
- •
- •
- 010 =Interrupt priority is 2
- 001 = Interrupt priority is 1
- 000 = Interrupt is disabled

bit 25-24 **IS3<1:0>:** Interrupt Subpriority bits

- 11 = Interrupt subpriority is 3
- 10 = Interrupt subpriority is 2
- 01 = Interrupt subpriority is 1
- 00 = Interrupt subpriority is 0

bit 23-21 Unimplemented: Read as '0'

- bit 20-18 **IP2<2:0>:** Interrupt Priority bits
 - 111 = Interrupt priority is 7
 - •
 - •
 - 010 = Interrupt priority is 2
 - 001 = Interrupt priority is 1
 - 000 = Interrupt is disabled
- bit 17-16 **IS2<1:0>:** Interrupt Subpriority bits
 - 11 = Interrupt subpriority is 3
 - 10 = Interrupt subpriority is 2
 - 01 = Interrupt subpriority is 1
 - 00 = Interrupt subpriority is 0
- bit 15-13 Unimplemented: Read as '0'
- **Note 1:** This register represents a generic definition of the IPCx register. Refer to Table 7-3 for the exact bit definitions.

REGISTER 7-7: IPCx: INTERRUPT PRIORITY CONTROL REGISTER x⁽¹⁾ (CONTINUED)

- bit 12-10 IP1<2:0>: Interrupt Priority bits
- 111 = Interrupt priority is 7 010 = Interrupt priority is 2 001 = Interrupt priority is 1 000 = Interrupt is disabled bit 9-8 IS1<1:0>: Interrupt Subpriority bits 11 = Interrupt subpriority is 3 10 = Interrupt subpriority is 2 01 = Interrupt subpriority is 1 00 = Interrupt subpriority is 0 Unimplemented: Read as '0' bit 7-5 bit 4-2 IP0<2:0>: Interrupt Priority bits 111 = Interrupt priority is 7 010 = Interrupt priority is 2 001 = Interrupt priority is 1 000 = Interrupt is disabled bit 1-0 ISO<1:0>: Interrupt Subpriority bits 11 = Interrupt subpriority is 3 10 = Interrupt subpriority is 2 01 = Interrupt subpriority is 1
 - 00 = Interrupt subpriority is 0
- **Note 1:** This register represents a generic definition of the IPCx register. Refer to Table 7-3 for the exact bit definitions.

REGISTER 14-1: UXMODE: UARTX MODE REGISTER (CONTINUED)

bit 11	RTSMD: Mode Selection for UxRTS Pin bit
	0 = UxRTS pin is in Flow Control mode
bit 10	Unimplemented: Read as '0'
bit 9-8	UEN<1:0>: UARTx Enable bits ⁽¹⁾
	 11 = UxTX, UxRX and UxBCLK pins are enabled and used; UxCTS pin is controlled by corresponding bits in the PORTx register 10 = UxTX, UxRX, UxCTS and UxRTS pins are enabled and used 01 = UxTX, UxRX and UxRTS pins are enabled and used; UxCTS pin is controlled by corresponding bits in the PORTx register 00 = UxTX and UxRX pins are enabled and used; UxCTS and UxRTS/UxBCLK pins are controlled by corresponding bits in the PORTx register
bit 7	WAKE: Enable Wake-up on Start Bit Detect During Sleep Mode bit
	1 = Wake-up is enabled0 = Wake-up is disabled
bit 6	LPBACK: UARTx Loopback Mode Select bit
	1 = Loopback mode is enabled0 = Loopback mode is disabled
bit 5	ABAUD: Auto-Baud Enable bit
	 1 = Enables baud rate measurement on the next character – requires reception of a Sync character (0x55); cleared by hardware upon completion 0 = Baud rate measurement is disabled or has completed
bit 4	RXINV: Receive Polarity Inversion bit
	1 = UxRX Idle state is '0' 0 = UxRX Idle state is '1'
bit 3	BRGH: High Baud Rate Enable bit
	 1 = High-Speed mode – 4x baud clock is enabled 0 = Standard Speed mode – 16x baud clock is enabled
bit 2-1	PDSEL<1:0>: Parity and Data Selection bits
	 11 = 9-bit data, no parity 10 = 8-bit data, odd parity 01 = 8-bit data, even parity 00 = 8-bit data, no parity
bit 0	STSEL: Stop Selection bit
	1 = 2 Stop bits 0 = 1 Stop bit

Note 1: These bits are present for legacy compatibility and are superseded by PPS functionality on these devices (see Section 9.8 "Peripheral Pin Select (PPS)" for more information).

REGISTER 18-2: CLCxSEL: CLCx INPUT MUX SELECT REGISTER (CONTINUED)

bit 10-8 DS3<2:0>: Data Selection MUX 3 Signal Selection bits

For CLC1:

- 111 = SCCP3 compare match event
- 110 = SCCP2 compare match event
- 101 = SCCP2 OCM2 output
- 100 = UART1 RX input
- 011 = SPI1 SDO output
- 010 = Comparator 2 output
- 001 = CLC1 output
- 000 = CLCINA I/O pin

For CLC2:

- 111 = SCCP3 compare match event
- 110 = SCCP2 compare match event
- 101 = SCCP2 OCM2 output
- 100 = UART2 RX input
- 011 = SPI2 SDO output
- 010 = Comparator 2 output
- 001 = CLC2 output
- 000 = CLCINA I/O pin
- bit 7 Unimplemented: Read as '0'
- bit 6-4 DS2<2:0>: Data Selection MUX 2 Signal Selection bits

For CLC1:

- 111 = Reserved
- 110 = MCCP1 compare match event
- 101 = Reserved
- 100 = ADC End-of-Conversion (EOC) event
- 011 = UART1 TX output
- 010 = Comparator 1 output
- 001 = CLC2 output
- 000 = CLCINB I/O pin

For CLC2:

- 111 = Reserved
- 110 = MCCP1 compare match event
- 101 = Reserved
- 100 = ADC End-of-Conversion event
- 011 = UART2 TX output
- 010 = Comparator 1 output
- 001 = CLC1 output
- 000 = CLCINB I/O pin

bit 3 Unimplemented: Read as '0'

- bit 2-0 DS1<2:0>: Data Selection MUX 1 Signal Selection bits
 - 111 = MCCP1 OCM1C output
 - 110 = MCCP1 OCM1B output
 - 101 = MCCP1 OCM1A output
 - 100 = REFCLKO output
 - 011 = LPRC clock source
 - 010 = SOSC clock source
 - 001 = System clock (FSYS)
 - 000 = CLCINA I/O pin

19.1 Comparator Control Registers

TABLE 19-1: COMPARATOR 1 AND 2 REGISTER MAP

ess		n		Bits													s			
Virtual Addr (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Reset	
0000	CMOTAT	31:16	_	_	—	_	_	—	_	_	—	—	—	—	—	—	C2EVT	C1EVT	0000	
0900	CIVISTAT	15:0	-	-	SIDL	_	_	_	_	CVREFSEL	_	_	_	_	_	_	C2OUT	C10UT	0000	
0010		31:16	-	-	_	_	_	_	_	_	_	_	_	_	_	_	_	_	0000	
0910 CM1CO	CINICON	15:0	ON	COE	CPOL	_	_	_	CEVT	COUT	EVPO	L<1:0>	_	CREF	_	_	CCH	<1:0>	0000	
0930 CM2C	CM2CON	31:16	-	-	_	_	_	_	_	_	_	_	_	_	_	_	_	_	0000	
	CM2CON	CM2CON	CM2CON	15:0	ON	COE	CPOL	_	_	_	CEVT	COUT	EVPO	L<1:0>	—	CREF	_	_	CCH	<1:0>

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively.

20.0 CONTROL DIGITAL-TO-ANALOG CONVERTER (CDAC)

Note: This data sheet summarizes the features of the PIC32MM0064GPL036 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 45. "Control Digital-to-Analog Converter (CDAC)" (DS60001327) in the "PIC32 Family Reference Manual", which is available from the Microchip web site (www.microchip.com/PIC32). The information in this data sheet supersedes the information in the FRM.

The Control Digital-to-Analog Converter (CDAC) generates analog voltage corresponding to the digital input.

The CDAC has the following features:

- 32 Output Levels are Available
- Internally Connected to Comparators to Conserve Device Pins
- · Output can be Connected to a Pin

A block diagram of the CDAC module is illustrated in Figure 20-1.



FIGURE 20-1: CDAC BLOCK DIAGRAM

REGISTER 23-2: FICD/AFICD: ICD/DEBUG CONFIGURATION REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1
31:24	—	—	—	—	—	—		—
00.40	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1
23:10	—	—	—	—	—	—	_	—
45.0	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1
15:8	_	—	—	—	_	—	_	_
7:0	r-1	r-1	r-1	R/P	R/P	R/P	r-1	r-1
	_	_	_	ICS<	<1:0>	JTAGEN	_	_

Legend:	r = Reserved bit	P = Programmable bit
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 31-5 Reserved: Program as '1'

bit 4-3 ICS<1:0>: ICE/ICD Communication Channel Selection bits

11 = Communicates on PGEC1/PGED1

10 = Communicates on PGEC2/PGED2

01 = Communicates on PGEC3/PGED3

00 = Not connected

bit 2 JTAGEN: JTAG Enable bit

1 = JTAG is enabled

0 = JTAG is disabled

bit 1-0 Reserved: Program as '1'

REGISTER 23-5: FOSCSEL/AFOSCSEL: OSCILLATOR SELECTION CONFIGURATION REGISTER (CONTINUED)

- bit 2-0 FNOSC<2:0>: Oscillator Selection bits
 - 110 and 111 = Reserved (selects Fast RC (FRC) Oscillator with Divide-by-N)
 - 101 = Low-Power RC Oscillator (LPRC)
 - 100 = Secondary Oscillator (SOSC)
 - 011 = Reserved
 - 010 = Primary Oscillator (XT, HS, EC)
 - 001 = Primary or FRC Oscillator with PLL
 - 000 = Fast RC (FRC) Oscillator with Divide-by-N

REGISTER 23-6: FSEC/AFSEC: CODE-PROTECT CONFIGURATION REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
01.04	R/P	r-1	r-1	r-1	r-1	r-1	r-1	r-1
31:24	CP	—	_	_	—	—	—	—
00.40	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1
23:10	—	—	-	-	—	—	-	—
15.0	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1
15:8	—	—	-	-	—	—	—	—
7:0	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1
			_	_		_	_	

Legend:	r = Reserved bit	P = Programmable bit			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31 CP: Code Protection Enable bit

1 = Code protection is disabled

0 = Code protection is enabled

bit 30-0 Reserved: Program as '1'

NOTES:

25.0 INSTRUCTION SET

The PIC32MM0064GPL036 family instruction set complies with the MIPS[®] Release 3 instruction set architecture. Only microMIPS32[™] instructions are supported. The PIC32MM0064GPL036 family does not have the following features:

- · Core extend instructions
- Coprocessor 1 instructions
- Coprocessor 2 instructions

Note:	Refer to the "M	IPS [®] Archite	ecture for
	Programmers	Volume II-	B: The
	microMIPS32™	Instruction	Set" at
	www.imgtec.com f	or more infori	mation.

Parameter No.	Typical ⁽¹⁾	Max	Units	Operating Temperature	Vdd	Conditions			
DC60	134	198	μA	-40°C					
	136	208	μA	+25°C	2.0V				
	141	217	μA	+85°C		Sleep with active main voltage regulate			
	139	209	μA	-40°C		PWRCON<0> = 1, RETEN (PWRCON<1>) = 0)			
	141	217	μA	+25°C	3.3V				
	143	231	μA	+85°C					
DC61	4.3	11.7	μA	-40°C					
	5.1	15.6	μA	+25°C	2.0V	Sleep with main voltage regulator in			
	11.4	34.3	μA	+85°C		Standby mode			
	6.1	16.8	μA	-40°C		(VREGS (PWRCON<0>) = 0,			
	6.9	20.1	μA	+25°C	3.3V	RETEN (PWRCON<1>) = 0)			
	12.7	36.0	μA	+85°C					
DC62	2.3	—	μA	-40°C					
	2.7	—	μA	+25°C	2.0V	Sleep with enabled retention voltage			
	5.2	—	μA	+85°C		regulator (VREGS (PWRCON<0>) = 1			
	2.3	—	μA	-40°C		RETEN (PWRCON<1>) = 1,			
	2.7	_	μA	+25°C	3.3V	REIVR(FPOR<2>)=0)			
	5.4	—	μA	+85°C					
DC63	0.28	_	μA	-40°C					
	0.44	_	μA	+25°C	2.0V	Sleep with enabled retention voltage			
	2.52	_	μA	+85°C		regulator (VREGS (PWRCON<0>) = 0,			
	0.29	—	μA	-40°C		RETEN (PWRCON<1>) = 1,			
	0.44		μA	+25°C	3.3V	REIVR(FPOR<2>)=0)			
-	2.62		μA	+85°C					

TABLE 26-6: POWER-DOWN CURRENT (IPD)⁽²⁾

Note 1: Data in the "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Base IPD is measured with:

- Oscillator is configured in FRC mode without PLL (FNOSC<2:0> (FOSCSEL<2:0>) = 000)
- OSC2 is configured as I/O in Configuration Words (OSCIOFNC (FOSCSEL<10>) = 1)
- FSCM is disabled (FCKSM<1:0> (FOSCSEL<15:14>) = 00)
- Secondary Oscillator circuits are disabled (SOSCEN (FOSCSEL<6>) = 0 and SOSCSEL (FOSCSEL<12>) = 0)
- Main and low-power BOR circuits are disabled (BOREN<1:0> (FPOR<1:0>) = 00 and LPBOREN (FPOR<3>) = 0)
- Watchdog Timer is disabled (FWDTEN (FWDT<15>) = 0)
- All I/O pins are configured as outputs and driving low
- No peripheral modules are operating or being clocked (defined PMDx bits are all ones)

28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN] With 0.55 mm Terminal Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	Ν	/ILLIMETERS	;	
Dimer	nsion Limits	MIN	NOM	MAX	
Number of Pins	N		28		
Pitch	е		0.65 BSC		
Overall Height	A	0.80	0.90	1.00	
Standoff	A1	0.00	0.02	0.05	
Terminal Thickness	A3	0.20 REF			
Overall Width	E	6.00 BSC			
Exposed Pad Width	E2	3.65	3.70	4.20	
Overall Length	D	6.00 BSC			
Exposed Pad Length	D2	3.65	3.70	4.20	
Terminal Width	b	0.23	0.30	0.35	
Terminal Length	L	0.50	0.55	0.70	
Terminal-to-Exposed Pad	K	0.20	-	-	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated

3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-105C Sheet 2 of 2

28-Lead Ultra Thin Plastic Quad Flat, No Lead Package (M6) - 4x4x0.6 mm Body [UQFN] With Corner Anchors

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS						
Dimension	MIN	NOM	MAX				
Number of Pins	N		28				
Pitch	е		0.40 BSC				
Overall Height	Α	-	-	0.60			
Standoff	A1	0.00	0.02	0.05			
Terminal Thickness	A3		0.152 REF				
Overall Width	E	4.00 BSC					
Exposed Pad Width	E2	1.80	1.90	2.00			
Overall Length	D		4.00 BSC				
Exposed Pad Length	D2	1.80	1.90	2.00			
Terminal Width	b	0.15	0.20	0.25			
Corner Anchor Pad	b1	0.40	0.45	0.50			
Corner Pad, Metal Free Zone	b2	0.18	0.23	0.28			
Terminal Length	L	0.30	0.45	0.50			
Terminal-to-Exposed-Pad	К	-	0.60	-			

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

- 2. Package is saw singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-333-M6 Rev A Sheet 2 of 2

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